

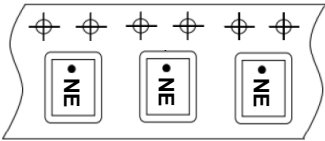
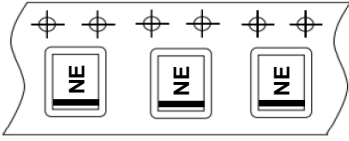

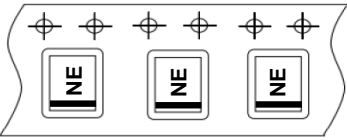


## Marking Information

|                             |  |
|-----------------------------|--|
| <p><b>DMN3730UFB-7</b></p>  | <div style="display: flex; justify-content: space-around; align-items: flex-start;"> <div style="text-align: center;">  <p>Top View<br/>Dot Denotes Drain Side</p> </div> <div style="text-align: center;"> <p>From date code 1527 (YYWW),<br/>this changes to:</p>  <p>Top View<br/>Bar Denotes Gate and Source Side</p> </div> </div> <div style="display: flex; justify-content: space-around; align-items: center; margin-top: 10px;">   </div> |
| <p><b>DMN3730UFB-7B</b></p> | <div style="text-align: center; margin-bottom: 10px;">  <p>Top View<br/>Bar Denotes Gate and Source Side</p> </div> <div style="display: flex; justify-content: space-between; align-items: center;">  <p>NE = Part Marking Code</p> </div>   |

## Maximum Ratings (@T<sub>A</sub> = +25°C unless otherwise specified.)

| Characteristic           |                        |                                 | Symbol           | Value | Unit |
|--------------------------|------------------------|---------------------------------|------------------|-------|------|
| Drain-Source Voltage     |                        |                                 | V <sub>DSS</sub> | 30    | V    |
| Gate-Source Voltage      |                        |                                 | V <sub>GSS</sub> | ±8    |      |
| Continuous Drain Current | V <sub>GS</sub> = 4.5V | (Note 6)                        | I <sub>D</sub>   | 0.91  | A    |
|                          |                        | T <sub>A</sub> = +70°C (Note 6) |                  | 0.73  |      |
|                          |                        | (Note 5)                        |                  | 0.75  |      |
| Pulsed Drain Current     |                        | (Note 7)                        | I <sub>DM</sub>  | 3     | A    |

## Thermal Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)

| Characteristic                          |          | Symbol                            | Value       | Unit |
|---|----------|-----------------------------------|-------------|------|
| Power Dissipation                       | (Note 6) | P <sub>D</sub>                    | 0.69        | W    |
|   | (Note 5) |                                   | 0.47        |      |
| Thermal Resistance, Junction to Ambient | (Note 6) | R <sub>θJA</sub>                  | 180         | °C/W |
|   | (Note 5) |                                   | 258         |      |
| Operating and Storage Temperature Range |          | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

## Electrical Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)

| Characteristic   | Symbol              | Min  | Typ  | Max  | Unit | Test Condition   |
|--|---------------------|------|------|------|------|--|
| <b>OFF CHARACTERISTICS</b>                             |                     |      |      |      |      |  |
| Drain-Source Breakdown Voltage                         | BV <sub>DSS</sub>   | 30   | -    | -    | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 10μA  |
| Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C | I <sub>DSS</sub>    | -    | -    | 1    | μA   | V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V  |
| Gate-Source Leakage                                    | I <sub>GSS</sub>    | -    | -    | 3    | μA   | V <sub>GS</sub> = ±8V, V <sub>DS</sub> = 0V  |
| <b>ON CHARACTERISTICS</b>                              |                     |      |      |      |      |  |
| Gate Threshold Voltage                                 | V <sub>GS(th)</sub> | 0.45 | -    | 0.95 | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                               |
| Static Drain-Source On-Resistance (Note 8)             | R <sub>DS(on)</sub> | -    | -    | 460  | mΩ   | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 200mA   |
|  |                     |      |      | 560  |      | V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 100mA   |
|  |                     |      |      | 730  |      | V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 75mA  |
| Forward Transfer Admittance                            | Y <sub>fs</sub>     | 40   | -    | -    | mS   | V <sub>DS</sub> = 3V, I <sub>D</sub> = 10mA  |
| Diode Forward Voltage (Note 8)                         | V <sub>SD</sub>     | -    | 0.7  | 1.2  | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 300mA   |
| <b>DYNAMIC CHARACTERISTICS (Note 9)</b>                |                     |      |      |      |      |  |
| Input Capacitance                                      | C <sub>iss</sub>    | -    | 64.3 | -    | pF   | V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V,<br>f = 1.0MHz                               |
| Output Capacitance                                     | C <sub>oss</sub>    | -    | 6.1  | -    | pF   |  |
| Reverse Transfer Capacitance                           | C <sub>rss</sub>    | -    | 4.5  | -    | pF   |  |
| Gate Resistance  | R <sub>g</sub>      | -    | 70   | -    | Ω    | V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz                                     |
| Total Gate Charge                                      | Q <sub>g</sub>      | -    | 1.6  | -    | nC   | V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 15V,<br>I <sub>D</sub> = 1A                    |
| Gate-Source Charge                                     | Q <sub>gs</sub>     | -    | 0.2  | -    | nC   |  |
| Gate-Drain Charge                                      | Q <sub>gd</sub>     | -    | 0.2  | -    | nC   |  |
| Turn-On Delay Time                                     | t <sub>D(on)</sub>  | -    | 3.5  | -    | ns   | V <sub>DS</sub> = 10V, I <sub>D</sub> = 1A<br>V <sub>GS</sub> = 10V, R <sub>G</sub> = 6Ω |
| Turn-On Rise Time                                      | t <sub>r</sub>      | -    | 2.8  | -    | ns   |  |
| Turn-Off Delay Time                                    | t <sub>D(off)</sub> | -    | 38   | -    | ns   |  |
| Turn-Off Fall Time                                     | t <sub>f</sub>      | -    | 13   | -    | ns   |  |

- Notes:
5. For a device surface mounted on a minimum recommended pad layout of an FR4 PCB, in still air conditions; the device is measured when operating in steady-state condition.
  6. Same as Note 5, except the device measured at t ≤ 10 seconds.
  7. Same as Note 5, except the device is pulsed at duty cycle of 1% for a pulse width of 10μs.
  8. Measured under pulsed conditions to minimize self-heating effect. Pulse width ≤ 300μs; duty cycle ≤ 2%.
  9. For design aid only, not subject to production testing.

**DMN3730UFB**

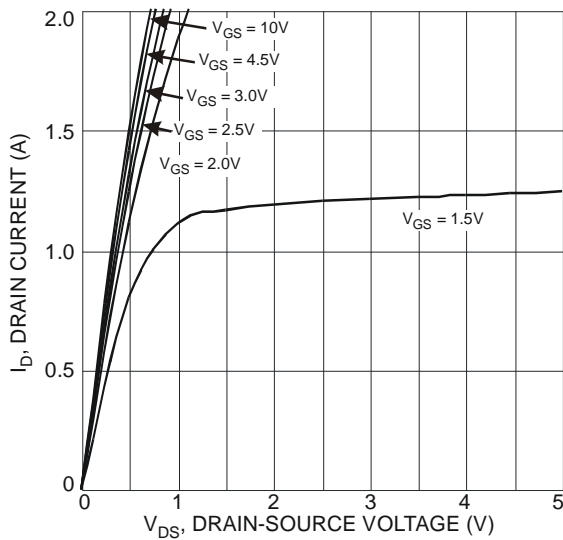


Fig. 1 Typical Output Characteristic

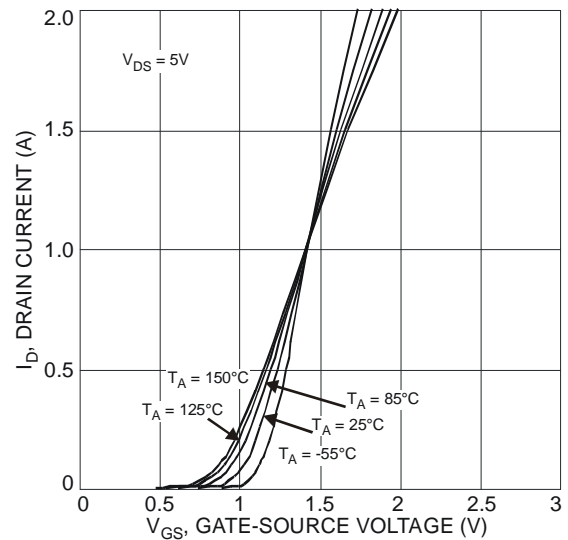


Fig. 2 Typical Transfer Characteristic

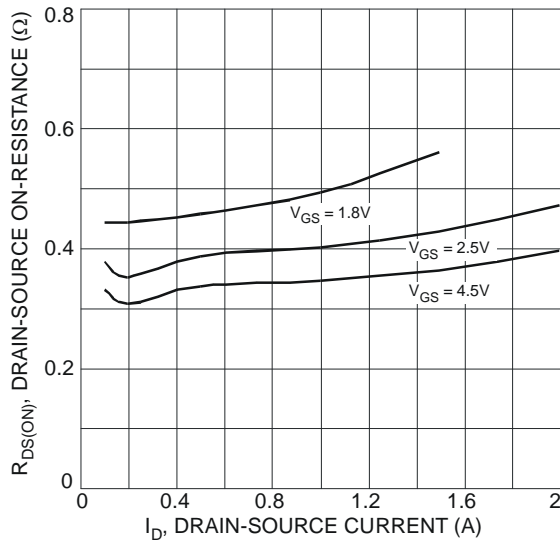


Fig. 3 Typical On-Resistance  
vs. Drain Current and Gate Voltage

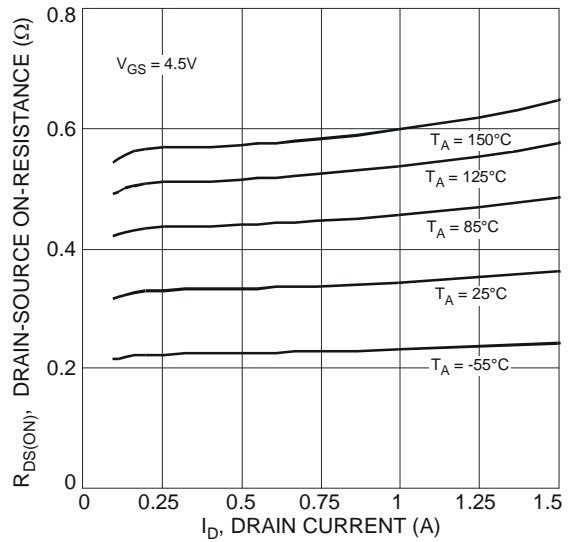


Fig. 4 Typical On-Resistance  
vs. Drain Current and Temperature

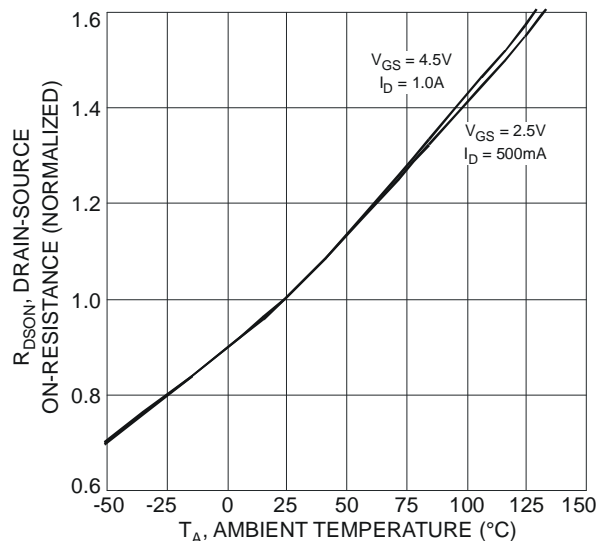


Fig. 5 On-Resistance Variation with Temperature

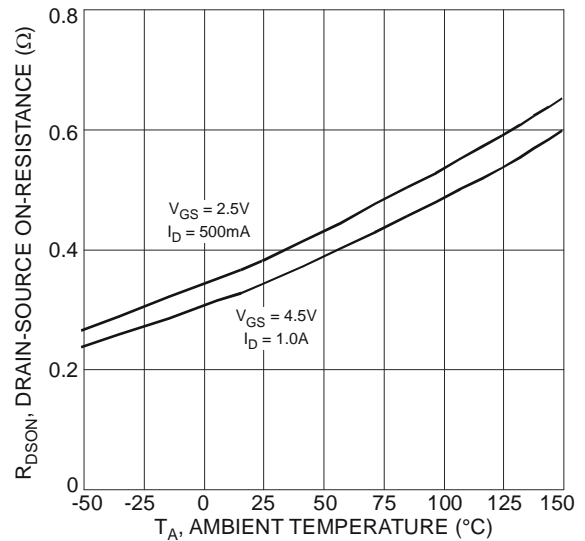


Fig. 6 On-Resistance Variation with Temperature

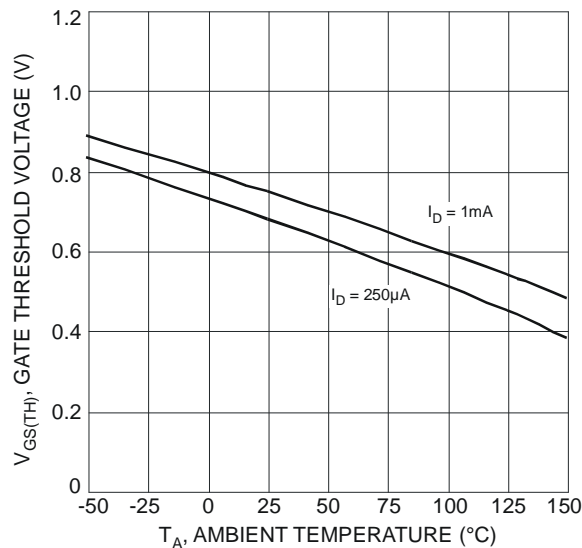


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

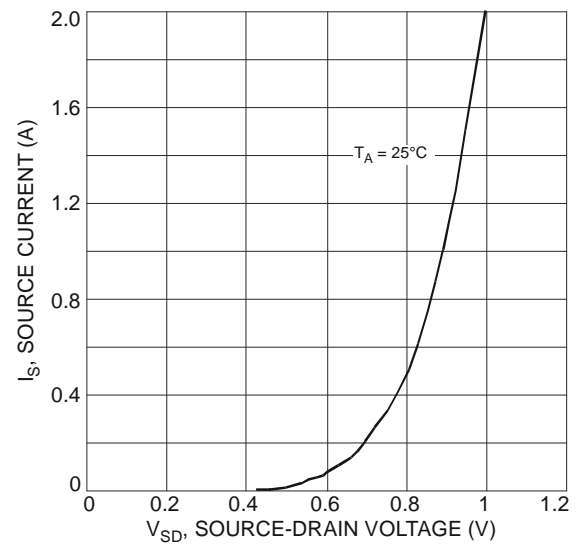


Fig. 8 Diode Forward Voltage vs. Current

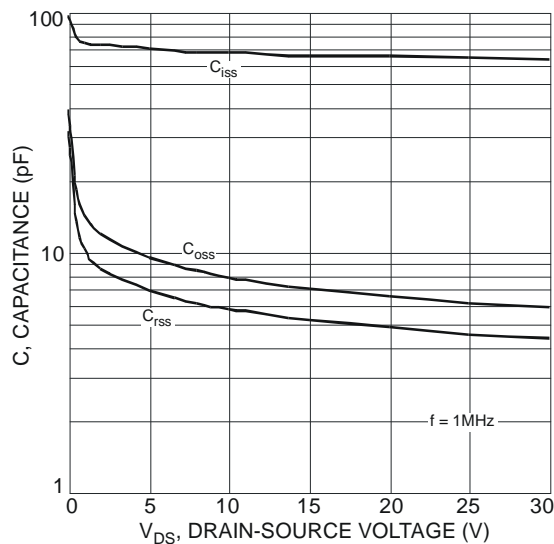


Fig. 9 Typical Total Capacitance

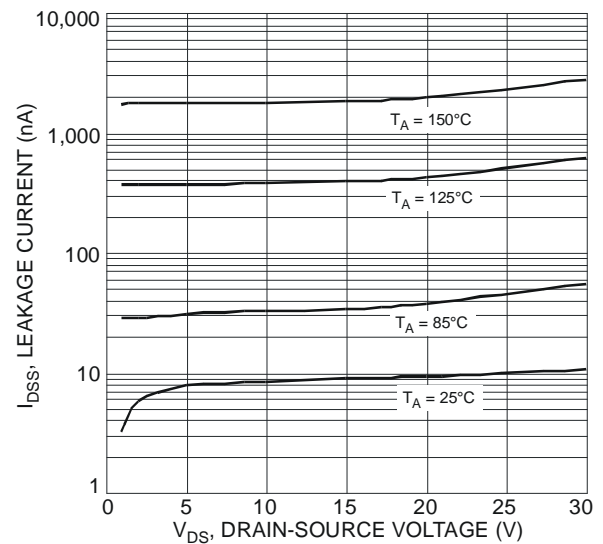


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage

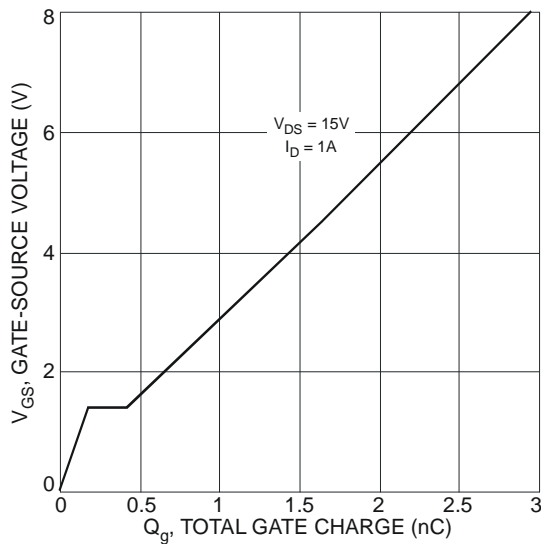


Fig. 11 Gate-Charge Characteristics

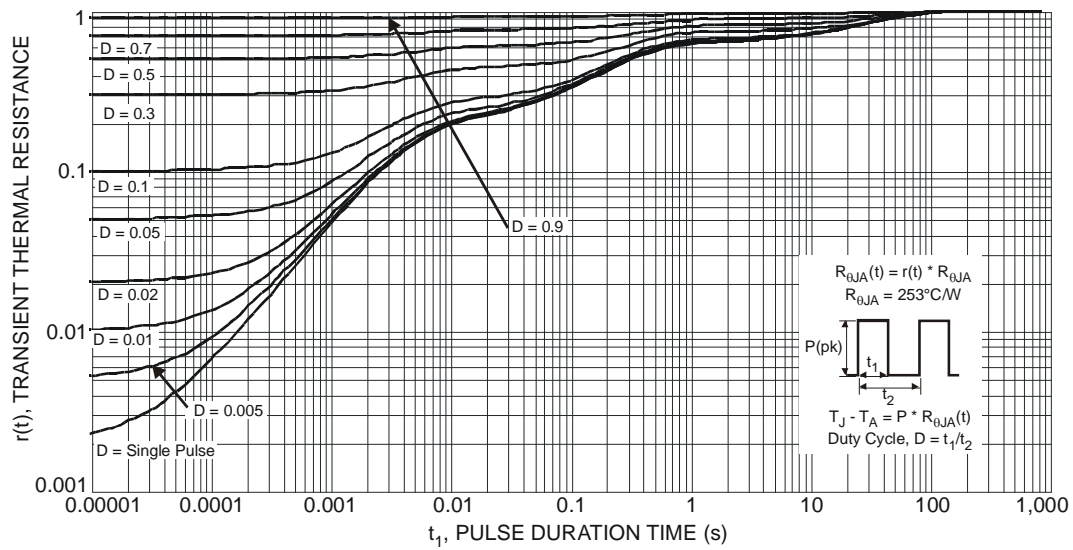
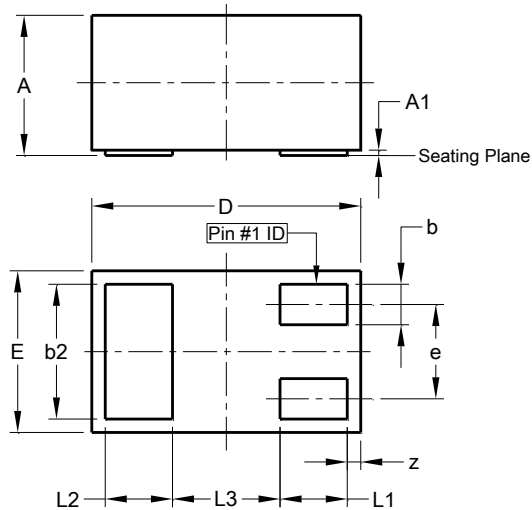


Fig. 12 Transient Thermal Response

## Package Outline Dimensions

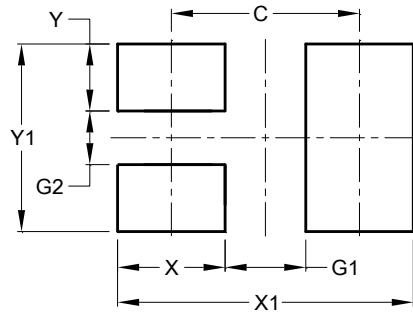
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



| X1-DFN1006-3         |      |       |      |
|----------------------|------|-------|------|
| Dim                  | Min  | Max   | Typ  |
| A                    | 0.47 | 0.53  | 0.50 |
| A1                   | 0.00 | 0.05  | 0.03 |
| b                    | 0.10 | 0.20  | 0.15 |
| b2                   | 0.45 | 0.55  | 0.50 |
| D                    | 0.95 | 1.075 | 1.00 |
| E                    | 0.55 | 0.675 | 0.60 |
| e                    | -    | -     | 0.35 |
| L1                   | 0.20 | 0.30  | 0.25 |
| L2                   | 0.20 | 0.30  | 0.25 |
| L3                   | -    | -     | 0.40 |
| z                    | 0.02 | 0.08  | 0.05 |
| All Dimensions in mm |      |       |      |

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.70          |
| G1         | 0.30          |
| G2         | 0.20          |
| X          | 0.40          |
| X1         | 1.10          |
| Y          | 0.25          |
| Y1         | 0.70          |

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